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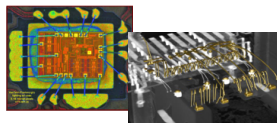
SYENSQO

- ▶ Gross/Fine Leak Detection Fluid
- ▶ Thermal Shock Fluid
- ▶ Liquid Burn-In Test Fluid
- ▶ Lead Free & Vapor Phase Soldering Fluid
- ▶ Solef 6008 PVDF Semi-crystalline Thermoplastics



NORDSON TEST & INSPECTION

- ▶ SQ3000+ Multi-Function System capable of performing AOI, SPI and CMM in-line.
- ▶ XS Series - High Resolution Inline Automated X-Ray Inspection



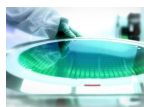
SURON PRECISION TECHNOLOGY

- ▶ Thermal and Heat Transfer Components
- ▶ Thermal and Getter Lids, Solder Preforms
- ▶ Carrier and Ceramic Substrates
- ▶ EMI/RFI Shielding Components



CAMTEK

- ▶ Sub-micron Defect Wafer Inspection System.
- ▶ Wafer Inspection for Advanced Interconnect Packaging, Memory, CMOS Image Sensors, MEMS and RF, with Metrology



MICROPOINT PRO - PRECISION BONDING TOOLS

- ▶ Advanced Wedge Bonding Tools
- ▶ Die Collets & Vacuum Pick Up Tools
- ▶ Fluid Dispensing Tools
- ▶ Custom Micro-Components
- ▶ Manual Wire Bonders(Wedge, Ball, Dual)



RGT INC.

- ▶ 6", 8", 12" Wafer Frames
- ▶ SS Mounting Film Frames
- ▶ Plastic Film Frames



KYOCERA INTERNATIONAL INC

- ▶ Electronic Mold Compound
- ▶ Die Attach Pastes: Conductive & Non-Conductive



DISCO HI-TEC AMERICA (Baja California)

- ▶ Wafer Grinding
- ▶ Saw & Laser Singulation
- ▶ Dicing Blades, Backgrind Tape, Backgrind Wheels
- ▶ KKM Wafer Processing Services



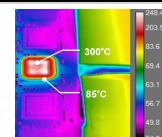
NORDSON DAGE X-RAY

- ▶ Dage Quadra 5 & 7 X-Ray Systems
- ▶ Dage XM8000 Fully Automated Metrology X-Ray



LASERSSEL CORPORATION

- ▶ Laser Compression Bonding
- ▶ Laser Selective Reflow
- ▶ Laser Sintering Bonding



ROKKO SYSTEMS & ROKKO LEADFRAMES PTE LTD.

- ▶ Fully Integrated Package Saw Singulation Systems
- ▶ Stand-Alone Pick and Place Systems
- ▶ Custom Tooling & Conversion Kits



BOSCHMAN ADVANCED PACKAGING TECHNOLOGY

- ▶ Packaging Development
- ▶ Through Polymer Via Technology
- ▶ Assembly Services
- ▶ Film Assisted Transfer Molding
- ▶ Pressurized Ag Sintering Systems



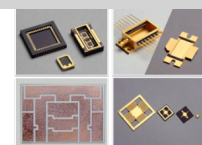
ROYCE INSTRUMENTS

- ▶ Bond Testers: Wire Pull / Bond Shear / Die Shear
- ▶ Die Sorters: Semi & Automated



NGK ELECTRONICS DEVICES, INC.

- ▶ Multilayer Ceramics
- ▶ Optical/High Speed Packages
- ▶ Pressed Ceramics
- ▶ Electronic Functional Components



SEPARATION TECHNOLOGISTS (a ResinTech Company)

- ▶ Total Solutions for Industrial Water Recycling.
- ▶ Closed Loop DI Water, Water Purification, Waste Water Treatment

